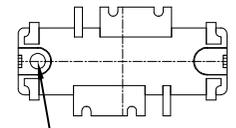
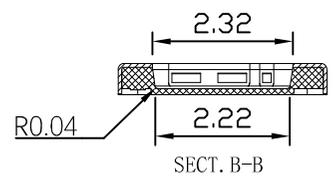
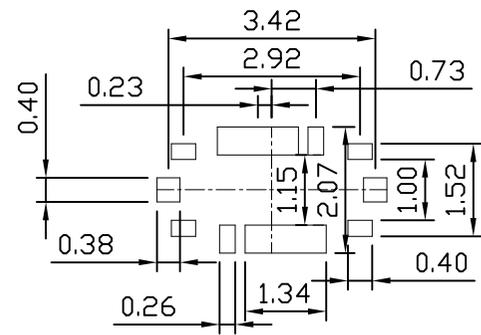
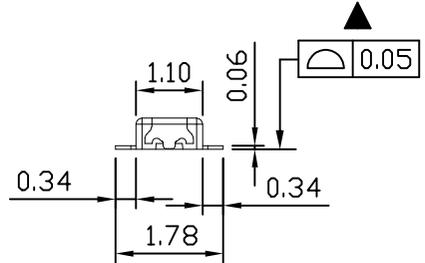
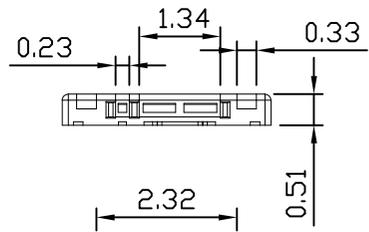
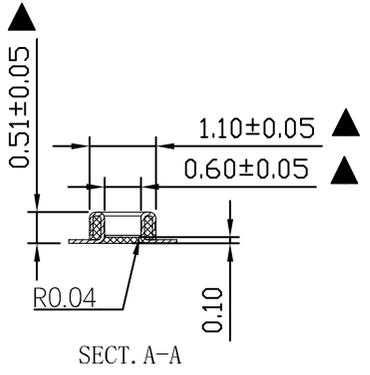
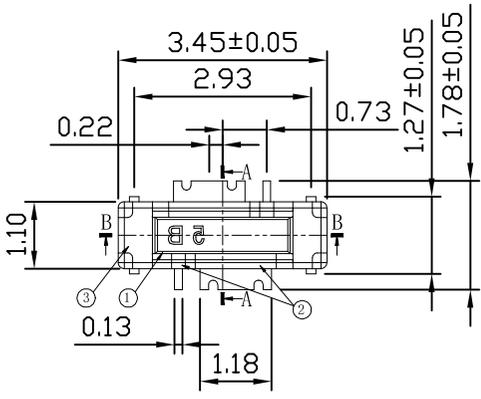
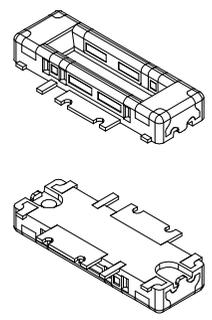
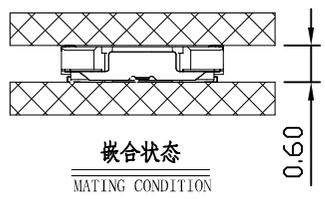
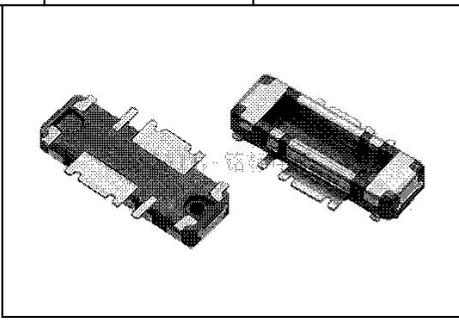


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进胶点，不许高出胶芯面

NO.	DESCRIPTION	QTY.	MATERIAL	FINISH	REMARKS
3	HOLD DOWN	2	C5191	GOLD (5u" MIN.), NICKEL 50u" MIN. OVER ALL	CONTACT AREA : GOLD (5u" MIN)
2	POWER CONTACT	4	C7025	GOLD (5u" MIN.), NICKEL 50u" MIN. OVER ALL	CONTACT AREA : GOLD (5u" MIN)
1	INSULATOR	1	LCP	—	—

- 备注:
1. 塑胶材质: LCP UL 94V-0 BLACK;
  2. 端子材质: C7025 T=0.06mm;
  3. 固定片材质: C5191 T=0.06mm;
  4. 模穴号 (3A~3X), 24穴/模;
  5. ▲符号为QIP管控尺寸;
  6. 电镀:  
端子, 镀金5μ"MIN, 镍底50μ"MIN.  
固定片, 镀金5μ"MIN, 镍底50μ"MIN.



		东莞市铭标电子科技有限公司 Ming Biao Electronic Technology Co., Ltd.			
TOLERANCE		DESIGN	DATE	TITLE	BTB
UNLESS OTHERWISE STATED		WYJ	2025.03.11		
X.X	±0.20	SIZE	A4	CHKD	DATE
X.XX	±0.15	REV	A	MODEL	MIB-006M004-K
X.XXX	±0.10	UNIT	mm	APPD	DATE
∠	±2°	SCALE	8:1	SHEET	1/3
				PRINT DATE	2025.03.11

